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Inducing hardening and healability in poly(ethylene-*co*-acrylic acid) via blending with complementary low molecular weight additives

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Supplementary Information

Contents		Page
Scheme S1	Synthetic route to compounds 3-5 .	S 1
Figures S1-S9	¹ H and ¹³ C NMR spectra of 3-6 in DMSO- d_6 or CD ₃ OD plus IR spectra.	S2
Figures S10-S12	Gelator 3 : rheology and UV-vis absorption characteristics.	S9
Figure S13	DSC data for pEAA15/1 (10% wt).	S 11
Figures S14-S20	Stress-strain curves for pEEA15 and additives 1-7 (1/5% wt).	S 11
Figures S21-S24	DSC thermograms for pEAA15/1-3 (0, 1 and 5% wt).	S15
Figures S25-S28	Relaxation DSC scans of pEEA15/1-3 (0, 1 and 5% wt).	S16
Tables S1-S3	Tensile properties of pEAA15 and pEEA15/1-3 after healing.	S18
Figures S29-S39	Stress-strain curves for pEAA15 and pEEA15/1-3 after healing	;. S19
Figures S40-S41	DSC thermograms of pEAA5 and pEAA20 with 1 and 3 .	S24
Figures S42-S45	Stress strain curves for pEAA20 with 1 and 3.	S25



Scheme S1; Generic synthesis of compounds 3-5 (3: $R_1 = H$, $R_2 = NO_2$. 4: $R_1 = NO_2$, $R_2 = H$. 5: $R_1 = H$, $R_2 = H$).



Figure S1; ¹H and ¹³C NMR spectra of 3 in DMSO- d_6



Figure S2; ¹H NMR spectrum of 3 in CD₃OD



Figure S3; IR spectra of 3



Figure S4; ¹H and ¹³C NMR spectra of 4 in DMSO- d_6



Figure S5; IR spectra of 4



Figure S6; ¹H and ¹³C NMR spectra of 5 in DMSO- d_6



Figure S7; IR spectra of 5



Figure S8; ¹H and ¹³C NMR spectra of 6 in DMSO- d_6



Figure S9; IR spectra of 6



Figure S10; Hydrogelator 3, CGC 2.7 mM (0.1%wt)



Figure S11; Rheology of aqueous gel of hydrogelator 3 (20 mM).



Figure S12; UV/vis absorption spectra of stirred solution of aqueous methylene blue (250 mL, 8 mg L^{-1}) after addition of hydrogelator **3** (1 mL, 80 mM).



Figure S13; DSC heating (lower) and cooling (upper) curves for pEAA15 /1 (10% wt) showing phase separation of polymer and dicarboxylic acid 1 (represented by the melting transition at 120 $^{\circ}$ C).



Figure S14; Stress strain curves (average of five samples) for; pEEA15 (black), pEEA15/1 (1% wt.) (red) and pEEA15/1 (5% wt.) (blue).



Figure S15; Stress strain curves (average of five samples) for pEEA15/2 (1% wt) (red) and pEEA15/2 (5% wt) (blue).



Figure S16; Stress strain curves (average of five samples) for pEEA15/3 (1% wt) (red) and pEEA15/3 (5% wt) (blue).



Figure S17; Stress strain curves (average of five samples) for pEAA15 and 4 at 1% (red) and 5% (blue) wt.



Figure S18; Stress strain curves (average of five samples) for pEAA15 and 5 at 1% (red) and 5% (blue) wt.



Figure S19; Stress strain curves (average of five samples) for pEAA15 and 6 at 1% (red) and 5% (blue) wt.



Figure S20; Stress strain curve (average of five samples) for pEAA15 and 7 at 1% wt.



Figure S21; DSC heating scan (below) and subsequent cooling scan (above) of pEEA15.



Figure S22; DSC heating/cooling scans of pEEA15/1 at 1% (red) and 5% weight (blue).



Figure S23; DSC heating/cooling scans of pEEA15/2 at 1% (red) and 5% weight (blue).



Figure S24; DSC heating/cooling scans of pEEA15/3 at 1% (red) and 5% weight (blue).



Figure S25; Relaxation DSC scan of pEEA15 (48 hours after scan shown in Figure S19).



Figure S26; Relaxation DSC scans of pEEA15 /1 at 1% (red) and 5% wt. (blue) (taken 48 hours after scan shown in Figure S20).



Figure S27; Relaxation DSC scan of pEEA15/2 at 1% (red) and 5% wt. (blue) (taken 48 hours after scan shown in Figure S21).



Figure S28; Relaxation DSC scan of pEEA15/3 at 1% (red) and 5% wt. (blue) (taken 48 hours after scan shown in Figure S22).

Film System	% wt additive	Tensile Strength (MPa)	Fracture Stress (MPa)	Uniform Strain (%)	Strain to Fracture (%)	Energy absorbed (MPa)	Young's Modulus (MPa)
pEEA15		0.12	0.12	1.56	1.60	0.002	5.68
pEEA15/1	5	0.09	0.09	0.53	0.56	0.001	13.12
pEEA15/2	1	0.57	0.57	1.50	1.58	0.013	23.23
pEEA15/3	5	0.88	0.88	2.30	2.42	0.013	18.61

Table S1; Tensile properties after heating fractured films at 50 °C for 8 hours.

Table S2; Tensile properties after heating fractured films at 60 °C for 2 hours.

Film System	% wt additive	Tensile Strength (MPa)	Fracture Stress (MPa)	Uniform Strain (%)	Strain to Fracture (%)	Energy absorbed (MPa)	Young's Modulus (MPa)
рЕЕА <i>15</i>		0.39	0.37	1.67	1.74	0.008	14.22
pEEA15/1	5	-	-	-	-	-	-
pEEA15/2	1	0.72	0.63	4.43	5.26	0.03	17.97
pEEA15/3	5	1.12	1.12	2.29	2.37	0.021	28.53

Table S3; Tensile properties after pressing (0.98 MPa) fractured films for 8 hours.

Film System	% wt additive	Tensile Strength (MPa)	Fracture Stress (MPa)	Uniform Strain (%)	Strain to Fracture (%)	Energy absorbed (MPa)	Young's Modulus (MPa)
рЕЕА <i>15</i>		1.00	0.84	6.15	7.38	0.06	26.31
pEEA15/1	5	1.35	0.93	6.75	9.68	0.10	21.83
pEEA15/2	1	0.20	0.15	1.07	1.23	0.007	18.60
pEEA15/3	5	1.95	0.96	5.62	7.48	0.14	41.43



Figure S29; Stress-strain curve (average of five samples) for pEAA15 after healing at 60 °C (2 hours)



Figure S30; Stress-strain curve (average of five samples) for **pEAA15/2** (1% wt) after healing at 60 °C (2 hours)



Figure S31; Stress-strain curve (average of five samples) for **pEAA15/3** (5% wt) after healing at 60 °C (2 hours)

Figure S32; Stress-strain curve (average of five samples) for pEAA15 after healing at 50 °C (8 hours).

Figure S33; Stress-strain curve for pEAA15/1 (5% wt) after healing at 50 °C (8 hours)

Figure S34; Stress-strain curve (average of five samples) for **pEAA15/3** (5% wt) after healing at 50 °C (8 hours)

Figure S35; Stress-strain curve (average of five samples) for **pEAA15/2** (1% wt) after healing at 50 °C (8 hours)

Figure S36; Stress-strain curve (average of five samples) for pEAA15 after healing under pressure (0.98 MPa, 8 hours)

Figure S37; Stress-strain curve (average of five samples) for **pEAA15**/1 (5% wt) after healing under pressure (0.98 MPa, 8 hours)

Figure S38; Stress-strain curve (average of five samples) for **pEAA15/2** (1% wt) after healing under pressure (0.98 MPa, 8 hours)

Figure S39; Stress-strain curve (average of five samples) for **pEAA15/3** (5% wt) after healing under pressure (0.98 MPa, 8 hours)

Figure S40; DSC thermograms for **pEAA20** (black) and **pEAA20/1** (blue) and **3** (red) each at 10% wt. The three lower traces are the heating scans and the three upper traces are the cooling scans.

Figure S41; DSC thermograms for pEAA5 (black) and pEAA5/1 (red) at 2% wt.

Figure S42; Stress-strain curve (average of five samples) of pEAA20.

Figure S43; Stress-strain curve of pEAA20/1 (10% wt).

Figure S44; Stress-strain curve (average of five samples) of pEAA20/3 (10% wt).

Figure S45; Stress-strain curve (average of five samples) of **pEAA20/3** (10% wt) after healing under pressure (0.98 MPa, 8 hours).